

<b>PATENT ASSIGNMENT COVER SHEET</b>
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EPAS ID: PAT4627926

<b>SUBMISSION TYPE:</b>	CORRECTIVE ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	Corrective Assignment to correct the ASSIGNOR'S NAMES AND ASSIGNEE ADDRESS previously recorded on Reel 015384 Frame 0981. Assignor(s) hereby confirms the ASSIGNMENT OF ASSIGNORS INTEREST.

**CONVEYING PARTY DATA**

Name	Execution Date
RONG-MING HO	04/28/2004
HUI-WEN FAN	04/28/2004
WEN-HSIEN TSENG	04/28/2004
YEO-WAN CHIANG	04/28/2004
CHU-CHIEN LIN	04/28/2004
BAO-TSAN KO	04/28/2004
BOR-HUNN HUANG	04/28/2004
HSI-HSIN SHIH	04/28/2004
JOUNG-YEI CHEN	04/28/2004

**RECEIVING PARTY DATA**

<b>Name:</b>	INDUSTRIAL TECHNOLOGY RESEARCH INSTITUTE
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<b>City:</b>	HSINCHU
<b>State/Country:</b>	TAIWAN

**PROPERTY NUMBERS Total: 1**

Property Type	Number
<b>Patent Number:</b>	7632544

**CORRESPONDENCE DATA****Fax Number:**

*Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.*

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**Address Line 1:** 615 HAMPTON DRIVE SUITE A202  
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<b>ATTORNEY DOCKET NUMBER:</b>	101X-0424-A22835-US
<b>NAME OF SUBMITTER:</b>	NELSON A. QUINTERO

<b>SIGNATURE:</b>	/Nelson A. Quintero/
<b>DATE SIGNED:</b>	10/05/2017
<b>Total Attachments: 6</b> source=assignment-pat-7632544#page1.tif source=assignment-pat-7632544#page2.tif source=assignment-pat-7632544#page3.tif source=assignment-pat-7632544#page4.tif source=assignment-pat-7632544#page5.tif source=assignment-pat-7632544#page6.tif	

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10/850169



To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies): 5-18-04  
**RONG-MING HO, HUI-WEN FAN, WEN-HSIEN  
TSENG, YEO-WAN CHIANG, FANG-HO LIN,  
CHU-CHIEN LIN, BAO-TSAN KO, BOR-HUNN  
HUANG, HSI-HSIN SHIH, and JOUNG-YEI CHEN**

Name and Address of Receiving Party(ies):  
Name: **Industrial Technology Research Institute**  
Address: **No. 195, Sec. 4, Chung Hsing Rd., Chutung  
Town, Hsinchu Hsien, TAIWAN, R.O.C.**

3. Nature of Conveyance: **Assignment**

Additional name(s) & address(es) attached  Yes  No

Execution Date: **04/28/04**

4. Application number(s) or patent number(s):

This document is being filed together with a new application on even date.

Title: **NANOPATTERNED TEMPLATES FROM ORIENTED DEGRADABLE DIBLOCK COPOLYMER  
THIN FILMS**

10850169

Patent Application Ser. No(s). and Filing Date(s):

Patent No(s):

5. Name and Address of Party To Whom Correspondence Concerning Document Should Be Mailed:

Name: **W. Wayne Liauh**  
Address: **Law Office of Liauh and Associates  
4224 Waialae Ave., Suite 5-388  
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Telecopier: (775) 559-0768**

6. Total Number of Applications and Patents Involved:  
1.

7. Total Fee (37 CFR 1.21(h)).....:  
**\$ 40.00**

8. Deposit account number:  
50-1260

8.

9. Statement and Signature:

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*

W. Wayne Liauh  
Name of Person Signing

Signature

5/18/04  
Date

Total number of pages comprising cover sheet: 1

06/01/2004 LNUELLER 00000149 501260 10850169

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ASSIGNMENT

WHEREAS, I (We), as named below and whose post office address(es) appear(s) below, hereinafter referred to as ASSIGNOR, have invented certain and useful improvements in:

NANOPATTERNED TEMPLATES FROM ORIENTED DEGRADABLE DIBLOCK COPOLYMER THIN FILMS

for which application for Letters Patent of the United States has been executed on even date herewith;

WHEREAS, Industrial Technology Research Institute, whose post office address is: No. 195, Sec. 4, Chung Hsing Rd., Chutung Town, Hsinchu Hsien, Taiwan, hereinafter referred to as ASSIGNEE, is desirous of acquiring the entire right, title and interest in and to said invention in the United States, and throughout the world;

NOW, THEREFORE, for good and valuable consideration, the receipt of all of which is hereby acknowledged, ASSIGNOR hereby sells, assigns and transfers unto ASSIGNEE the full and exclusive right, title and interest in and to said invention in the United States, and throughout the world, including priority rights created by any treaty or international convention to which the United States of America is a party, said patent application, and in and to any patent or patents obtained on said invention in the United States and all foreign countries, as fully set forth and described in the specification executed by me (us) under even date herewith preparatory to obtaining Letters Patent of the United States therefor, including any continuations, divisions, renewals, reissues, extensions and substitutes thereof, the said entire interest to be held and enjoyed by ASSIGNEE for its own use and behoof and for the use and behoof of its successors and assigns to the full end of the term for which said Letters Patent may be granted in the United States, extensions and substitutes thereof, as fully and entirely as the same would have been held and enjoyed by ASSIGNOR had this sale not been made;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent as may be known and accessible to ASSIGNOR and will testify as to the same in any interference or litigation related thereto and will promptly execute and deliver to ASSIGNEE or its legal representative any and all papers, instruments or affidavits required to apply for, obtain, maintain and enforce said application, said invention and said Letters Patent which may be necessary or desirable to carry out the purposes hereof; and

ASSIGNOR HEREBY AUTHORIZES and requests the Commissioner of Patents and Trademarks to issue any and all Letters Patent, including any divisions, renewals, reissues and extension thereof to ASSIGNEE the aforesaid interest in and to the same.

ASSIGNOR FURTHER HEREBY AUTHORIZES the Attorney of Record in this application to fill in below the Serial number and filing date of this application subsequent to our execution of this assignment:

Serial No. \_\_\_\_\_ - Filing Date: \_\_\_\_\_

Name of Inventor	Residence	Post Office Address	Citizenship	Signature	Date
Rong-Ming Ho	Hsinchu, TAIWAN	321 KUANG FU RD., SEC.2, HSINCHU 300, TAIWAN	TAIWAN	Rong-Ming Ho	4/28/2004
Hui-Wen Fan	Hsinchu, TAIWAN	321 KUANG FU RD., SEC.2, HSINCHU 300, TAIWAN	TAIWAN		
Wen-Hsien Tseng	Hsinchu, TAIWAN	321 KUANG FU RD., SEC.2, HSINCHU 300, TAIWAN	TAIWAN	Wen-Hsien Tseng	4/28/2004
Yeo-Wan Chiang	Hsinchu, TAIWAN	321 KUANG FU RD., SEC.2, HSINCHU 300, TAIWAN	TAIWAN	Yeo-Wan Chiang	4/28/2004
Chu-Chien Lin	Taichung, TAIWAN	250, KUO-KUANG RD., TAICHUNG CITY 402, TAIWAN	TAIWAN	Lin Chu-Chien	4/28/2004
Bao-Tsan Ko	Hsinchu, TAIWAN	321 KUANG FU RD., SEC.2, HSINCHU 300, TAIWAN	TAIWAN		
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Wen-Hsien Tseng	Hsinchu, TAIWAN	321 KUANG FU RD., SEC.2, HSINCHU 300, TAIWAN	TAIWAN		
Yeo-Wan Chiang	Hsinchu, TAIWAN	321 KUANG FU RD., SEC.2, HSINCHU 300, TAIWAN	TAIWAN		
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Wen-Hsien Tseng	Hsinchu, TAIWAN	321 KUANG FU RD., SEC.2, HSINCHU 300, TAIWAN	TAIWAN		
Yeo-Wan Chiang	Hsinchu, TAIWAN	321 KUANG FU RD., SEC.2, HSINCHU 300, TAIWAN	TAIWAN		
Chu-Chien Lin	Taichung, TAIWAN	250, KUO-KUANG RD., TAICHUNG CITY 402, TAIWAN	TAIWAN		
Bao-Tsan Ko	Hsinchu, TAIWAN	321 KUANG FU RD., SEC.2, HSINCHU 300, TAIWAN	TAIWAN	Bao-Tsan Ko	04/28/2004
Bor-Hunn Huang	Taichung, TAIWAN	250, KUO-KUANG RD., TAICHUNG CITY 402, TAIWAN	TAIWAN		
Hsi-Hsin Shih	Hsinchu, TAIWAN	321 KUANG FU RD., SEC.2, HSINCHU 300, TAIWAN	TAIWAN	Hsi-Hsin Shih	04/28/04

JOUNG-YEI, CHEN	Hsinchu, TAIWAN	321 KUANG FU RD., SEC.2, HSINCHU 300, TAIWAN	TAIWAN	<i>Joung Yei Chen</i>	<i>May 13, 2009</i>
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